Application Report
SimpleLink™ CC13XX, CC26XX, CC32XX and MSP432E4
Integer Overflow Issues

TI-PSIRT-2020-100074
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Summary
Below are the integer overflow issues in the SimpleLink™ CC13XX, CC26XX, CC32XX and MSP432E4 SDKs that could potentially lead to issues like heap overflows and remote code execution. These potential vulnerabilities cannot typically be used to compromise the device without another vulnerability allowing control of the function call parameters.

<table>
<thead>
<tr>
<th>CVEID</th>
<th>Description</th>
<th>CVSS score (v3.0)</th>
<th>CVSS vector</th>
</tr>
</thead>
</table>

Affected products
- CC13XX
- CC26XX
- CC32XX
- MSP432E4XX

Potentially impacted features
- TI-RTOS kernel heap manager
- FreeRTOS POSIX heap manager

Suggested mitigations
The following mitigations are released in the SDKs listed below. It is recommended that customers of affected products apply these suggested mitigations and consider further system-level security measures as appropriate.

- In tirtos/packages/ti/sysbios/rts/MemAlloc.xdt, ti_sysbios_rts_MemAlloc_alloc(), a check was added to return NULL if size + sizeof(Header) overflowed.
- In kernel/tirtos/packages/ti/sysbios/heaps/HeapTrack.c, HeapTrack_alloc(), a check was added to return NULL if size + res + sizeof(HeapTrack_Tracker) overflowed.
- In source/ti/posix/freertos/memory.c, malloc(), a check was added to return NULL if size + sizeof(Header) overflowed.
- In tirtos/packages/ti/sysbios/heaps/HeapMem.c HeapMem_allocUnprotected(), a check was added to return NULL if adjSize overflowed. HeapMem_allocUnprotected() and HeapMem_alloc() were removed from ROM on CC13XX and CC26XX devices.
The following SDK releases address the potential vulnerability:

<table>
<thead>
<tr>
<th>Affected SDK</th>
<th>SDK version with mitigations</th>
<th>SDK releases with mitigations</th>
</tr>
</thead>
<tbody>
<tr>
<td>CC32XX SDK</td>
<td>CC32XX SDK V4.40.00.07</td>
<td>Jan 2021</td>
</tr>
<tr>
<td>SIMPLELINK-CC13X2-26X2-SDK</td>
<td>SIMPLELINK-CC13X2-26X2-SDK V4.40.00</td>
<td>Jan 2021</td>
</tr>
<tr>
<td>SIMPLELINK-CC2640R2-SDK</td>
<td>SIMPLELINK-CC2640R2-SDK V4.40.00</td>
<td>Feb 2021</td>
</tr>
<tr>
<td>SIMPLELINK-CC13X0-SDK</td>
<td>SIMPLELINK-CC13X0-SDK V4.10.03</td>
<td>Feb 2021</td>
</tr>
</tbody>
</table>

The SimpleLink MSP432E4 SDK does not have a planned SDK update to address the mitigations discussed above due to the legacy nature of its software. The TI-RTOS and FreeRTOS files above are common between the mentioned SDKs. It is recommended that customers patch in the mentioned files from one of the updated SDKs above to the SimpleLink MSP432E4 SDK.

**Note:** Customers are solely responsible for the security of their products and are encouraged to assess the possible risk of any potential security vulnerability.

**Acknowledgment**

We would like to thank Omri Ben Bassat and David Atch of Microsoft for working with CISA to report these vulnerabilities to the TI Product Security Incident Response Team (PSIRT).

**Revision history**

- Version 1.0 Initial publication
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